

Implementation of WIPO Standard ST.91

Response ID:133 Data

1. Identification page

Please enter the ST.3 code and name of the member state or international organization you represent.

EP - European Patent Office (EPO)

Please enter the name of the office or organization you represent. For instance, Canadian Intellectual Property Office. If your organization name is the same as your ST.3 code name, you may put "n/a".

European Patent Office

Please enter your email address so we can contact you if we have questions about your response.

fferreira@epo.org

2. Questions page

Q 1. Does your Office currently use 3D models, 3D images or 3D chemical structures?

No

Q 1.1. If yes, for what IP rights:

Q 1.2. Does your Office implement WIPO Standard ST.91 within its work?

No

Q 2.1. What formats of 3D models, 3D images or 3D chemical structures does your Office currently accept for each IP right?

| | Trademarks | Industrial Designs | Inventions (except 3D chemical structures) | Utility models | Integrated circuit topology | Inventions (3D chemical structures) |
|---|------------|--------------------|--|----------------|-----------------------------|-------------------------------------|
| None, my Office doesn't operate this type of IP right | | | | | | |
| None, my Office doesn't accept 3D models, 3D images or 3D chemical structures for this type of IP right | | | | | | |
| 3D PDF | | | | | | |
| IGES | | | | | | |
| OBJ | | | | | | |
| STL | | | | | | |
| STEP/STP | | | | | | |
| U3D | | | | | | |
| MOL | | | | | | |
| CDX | | | | | | |

Other (please specify):

Q 2.2. What software does your Office currently use for the visualization of 3D models, 3D images or 3D chemical structures during the examination process?

Please specify:

Q 2.3. What formats of 3D models, 3D images or 3D chemical structures does your Office currently use for the electronic publication for each IP right operated by Office?

| | Trademarks | Industrial Designs | Inventions (except 3D chemical structures) | Utility models | Integrated circuit topology | Inventions (3D chemical structures) |
|---|------------|--------------------|--|----------------|-----------------------------|-------------------------------------|
| None, my Office doesn't operate this type of IP right | | | | | | |
| None, my Office doesn't publish information of this type of IP right electronically | | | | | | |
| None, my Office doesn't publish information of 3D models, 3D images or 3D chemical structures electronically even if they were accepted | | | | | | |
| 2D images received by my Office from the source 3D models or 3D images | | | | | | |
| 3D PDF | | | | | | |
| IGES | | | | | | |
| OBJ | | | | | | |
| STL | | | | | | |
| STEP/STP | | | | | | |
| U3D | | | | | | |
| MOL | | | | | | |
| CDX | | | | | | |

Other (please specify):

Q 2.4. What software does your Office currently use for the electronic publication of 3D models, 3D images or 3D chemical structures?

Q 2.5. What formats of 3D models, 3D images or 3D chemical structures does your Office currently use for the paper publication for each IP right?

| | Trademarks | Industrial Designs | Inventions (except 3D chemical structures) | Utility models | Integrated circuit topology | Inventions (3D chemical structures) |
|---|------------|--------------------|--|----------------|-----------------------------|-------------------------------------|
| None, my Office doesn't operate this type of IP right | | | | | | |
| None, my Office doesn't publish information of this type of IP right on paper | | | | | | |
| None, my Office doesn't publish information of 3D models, 3D images or 3D chemical structures on paper even if they were accepted | | | | | | |
| 2D images received by Office from the source 3D models or 3D images | | | | | | |
| Link to the 3D object online | | | | | | |

Other (please specify):

Q 2.6. Does your Office carry out search for the comparison of the 3D models and 3D images with 3D models and 3D images during the examination process and if so, in what formats for each IP right?

| | Trademarks | Industrial Designs | Inventions (except 3D chemical structures) | Utility models | Integrated circuit topology |
|--|------------|--------------------|--|----------------|-----------------------------|
| No | | | | | |
| Yes, my Office uses 2D representations of 3D models for the comparison | | | | | |
| Yes, my Office uses 3D models themselves for the comparison | | | | | |

Other (please specify):

Q 2.7. What software does your Office currently use for the comparison of the 3D models and 3D images with 3D models and 3D images during the examination process?

Q 2.8. Does your Office carry out search for the comparison of the 3D models and 3D images with 2D images during the examination process and if so, in what formats for each IP rights?

| | Trademarks | Industrial Designs | Inventions (except 3D chemical structures) | Utility models | Integrated circuit topology |
|--|------------|--------------------|--|----------------|-----------------------------|
| No | | | | | |
| Yes, my Office uses 2D representations of 3D models for the comparison | | | | | |
| Yes, my Office uses 3D representations of 2D images for the comparison | | | | | |

Other (please specify):

Q 2.9. What software does your Office currently use for the comparison of the 3D models and 3D images with 2D images during the examination process?

Q 3.1. Please describe existing practices or future plans for using 3D models, 3D images or 3D chemical structures within your Office

Q 3.2. Please describe existing practices or future plans relating to the implementation of WIPO Standard ST.91 within your Office

Q 4. Any other comments

4. Thank you

Send confirmation email

Apr 06, 2024 11:41:22 Success: Email Sent to: fferreira@epo.org,cws.surveys@wipo.int